



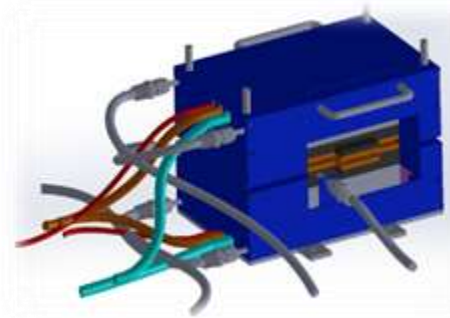
# Characterisation of thermoelectric generation modules: methods and uncertainties.

A. Cuenat P. Díaz-Chao, Ekaterina Selezneva, A. Muñiz-Piniella,

**National Physical Laboratory**  
**Materials division**  
Hampton Road, Teddington  
Middlesex – TW11 0LW  
(United Kingdom)

# Module metrology

At NPL, we are developing facilities to measure **traceably** the performance of thermoelectric generators (TEG)



L

“**Traceability**: the result can be related to a reference through a documented unbroken chain of **calibrations**, each contributing to the **measurement uncertainty**”

- **Precision: reproducibility**
- **Accuracy: “true value”**



Low accuracy  
High precision



Higher accuracy  
Low precision



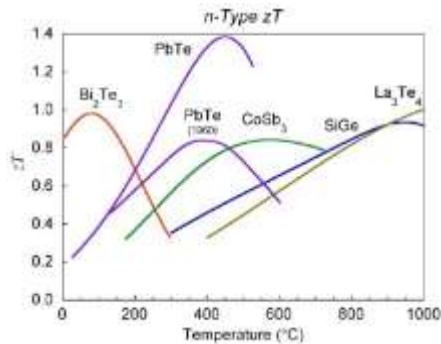
High accuracy  
High precision

Sources of uncertainty for TEGs

$$y = f(x_1, \dots, x_j, \dots, x_N)$$

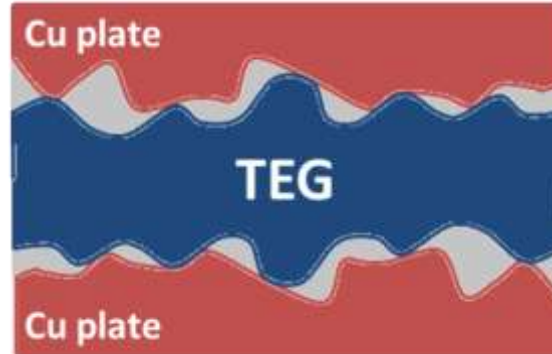
TE materials properties

- Physical phenomena
    - Average T
    - T stabilisation
    - Meas. method
- (const Heat Flux Vs. const T)



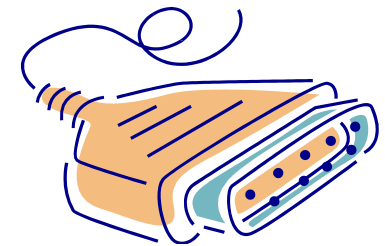
Thermal contact resistance

- Engineering:
  - Clamping pressure
  - Interface material
  - Environment (vacuum, air)



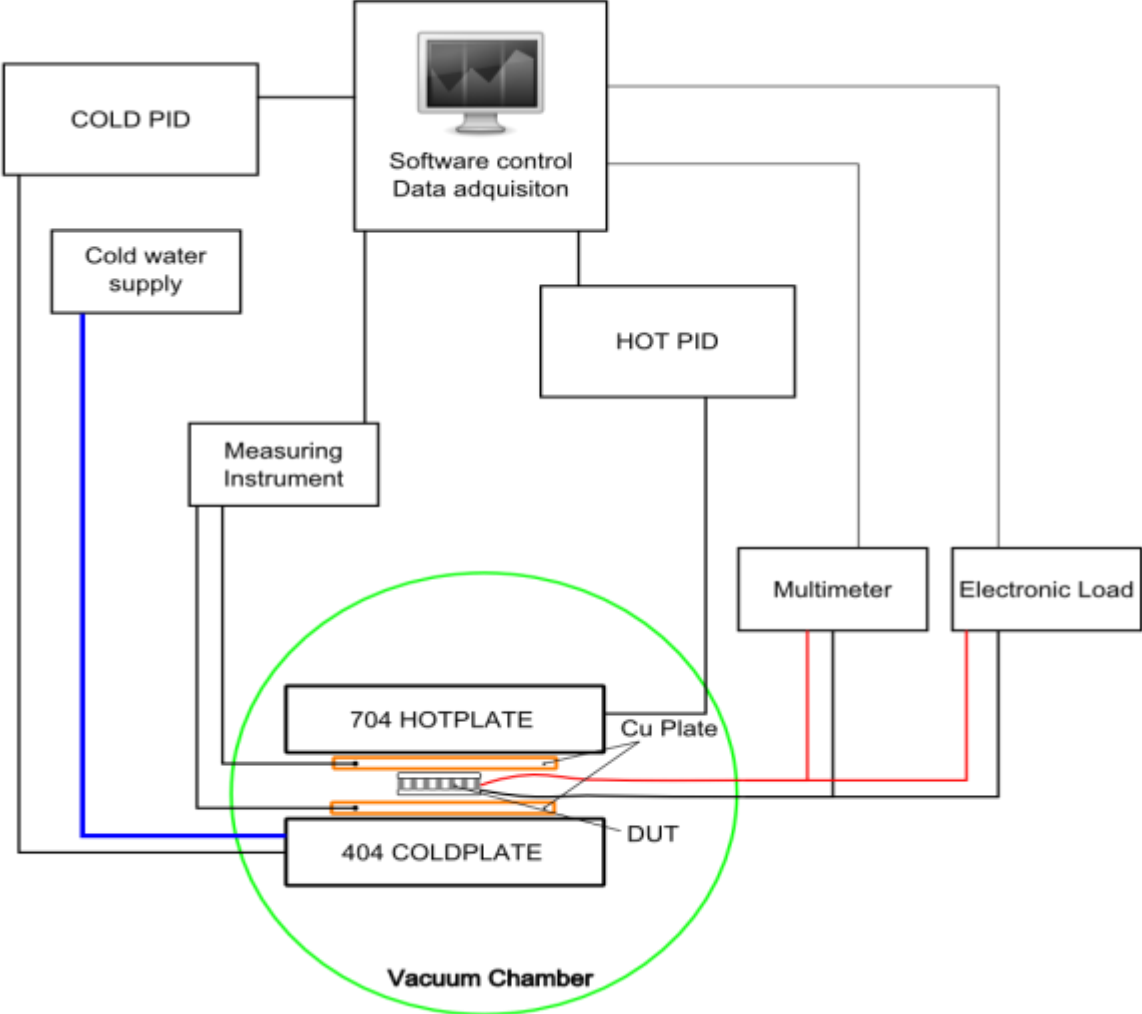
Data Acquisition

- Instrumental
  - Thermocouples
  - Electronic load
  - Multimeters



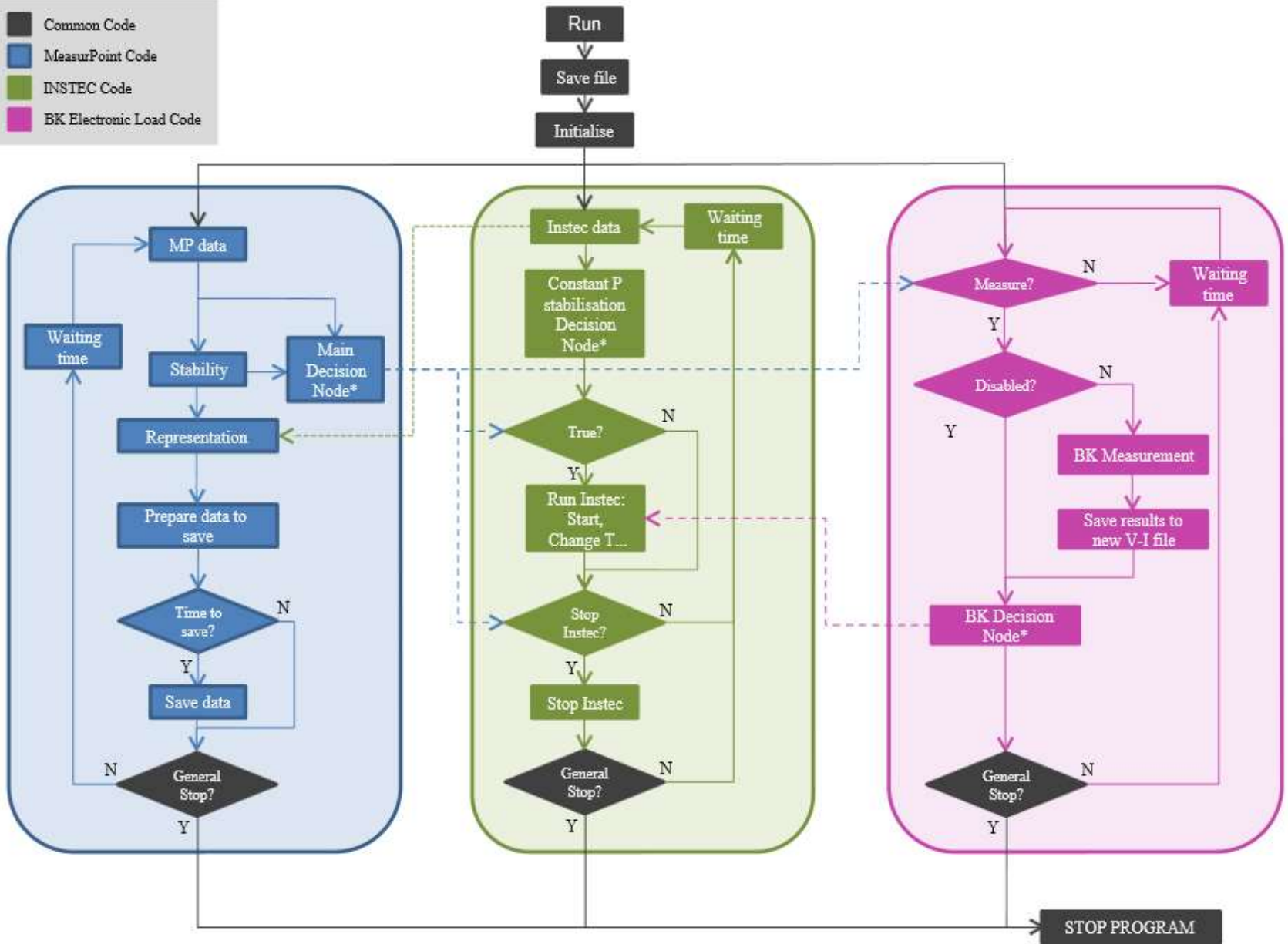
The main sources of uncertainty are those related to **materials properties** and **contact resistance**.

# Measurement setup

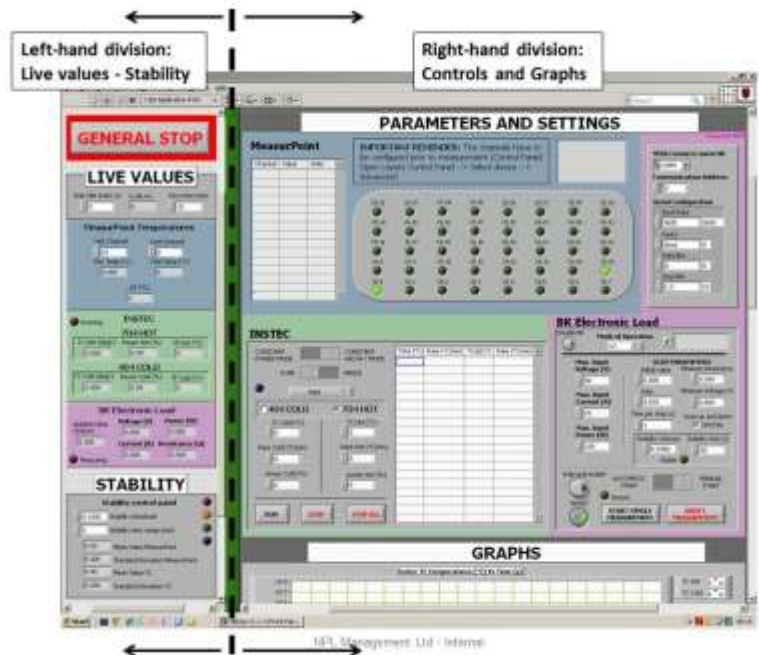
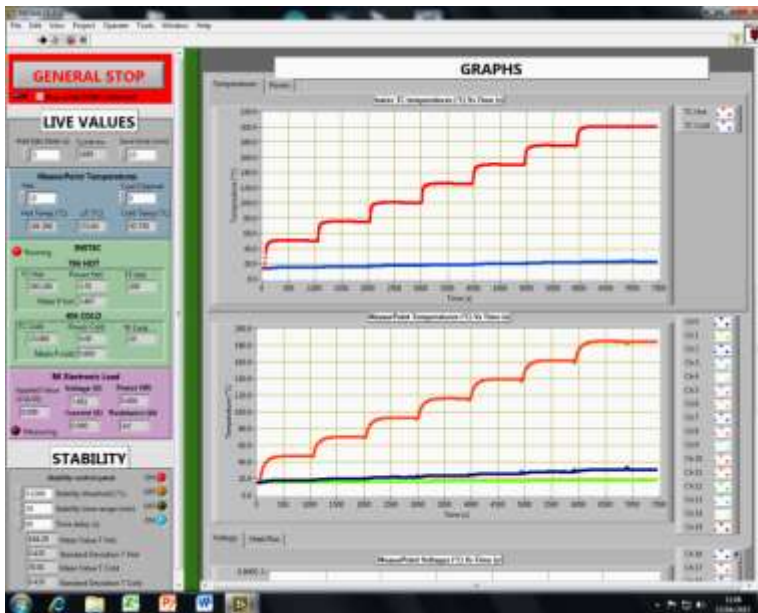
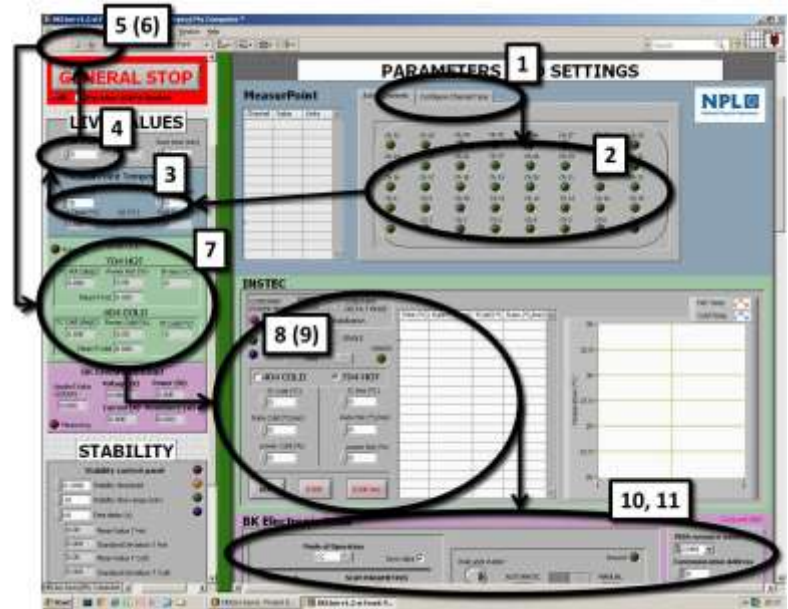
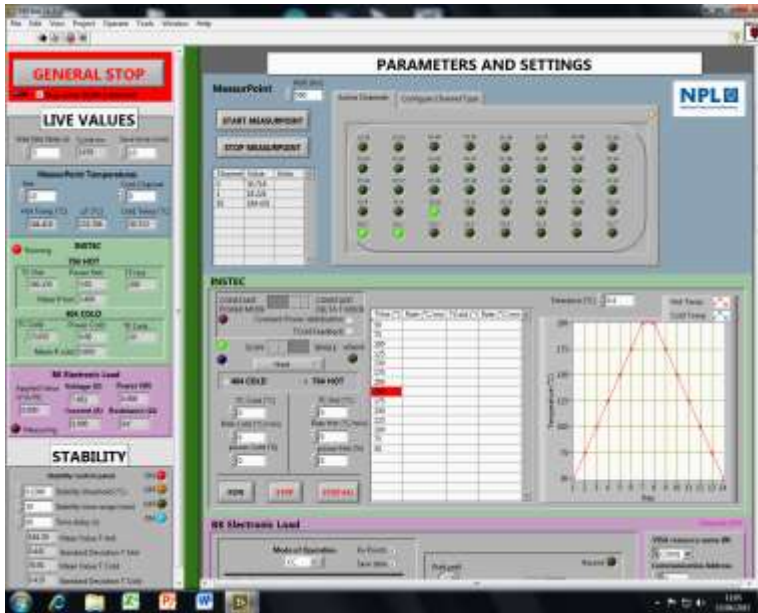


# Software flow chart

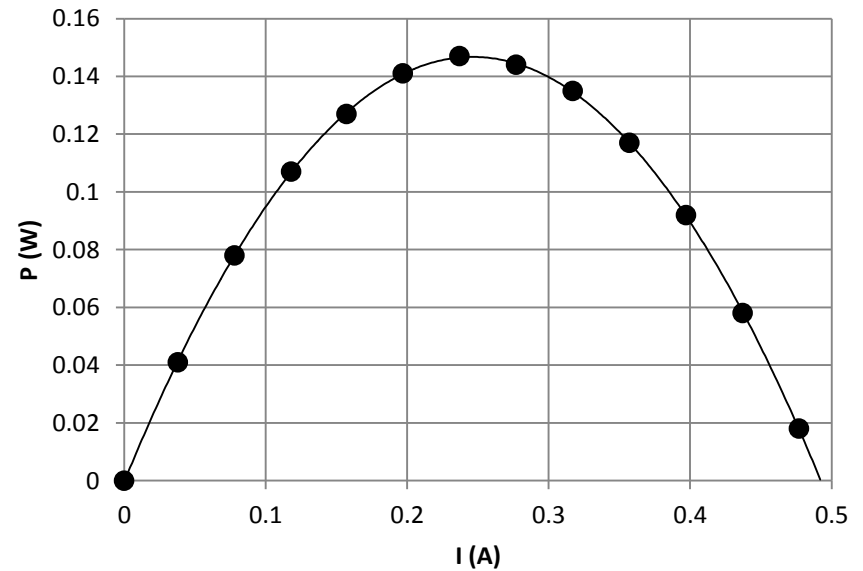
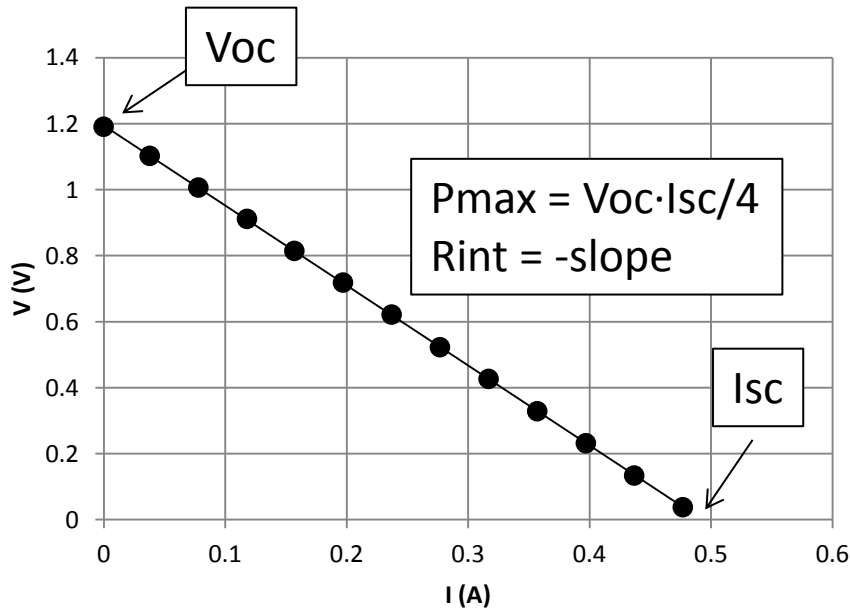
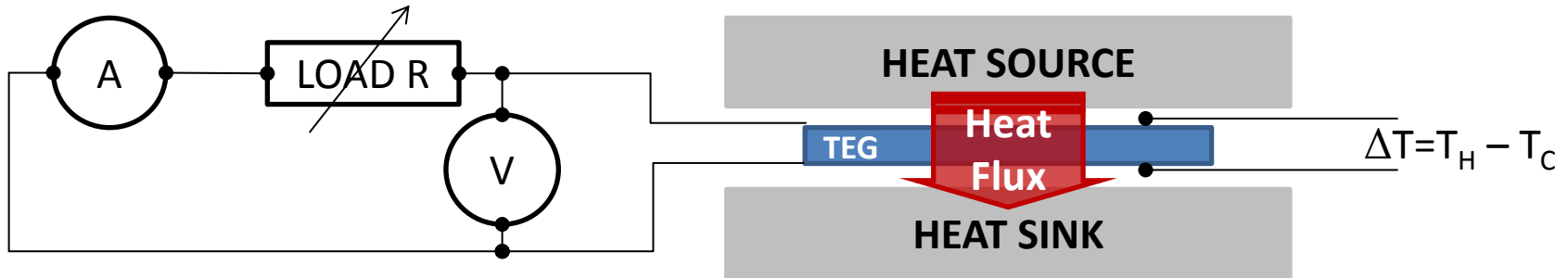
Common Code  
 MeasurPoint Code  
 INSTEC Code  
 BK Electronic Load Code





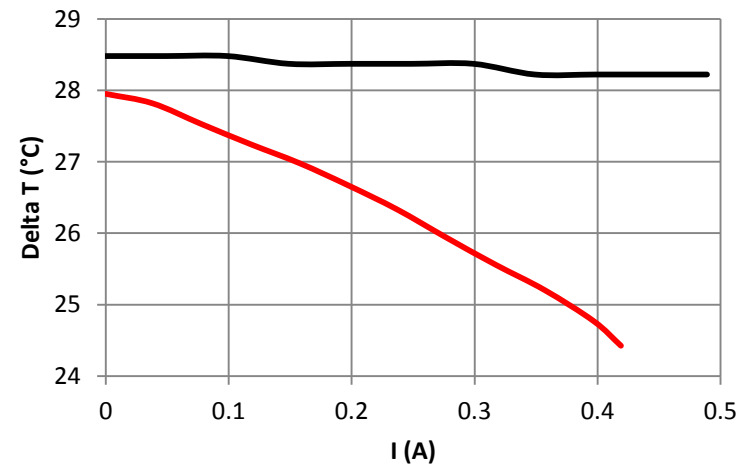
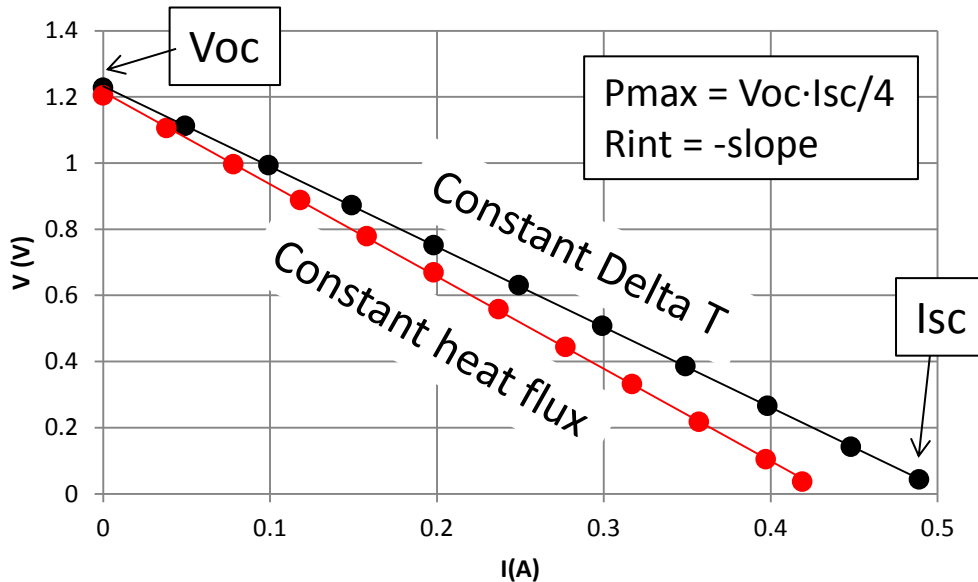


**Material properties:** How can they affect? → How is a TEG characterised?



### Constant heat flux Vs constant Delta T:

TEG works as a heat exchanger depending on the current



| Parameter | Constant T | Constant Heat Flux | Difference |
|-----------|------------|--------------------|------------|
| Voc       | 1.23 V     | 1.21 V             | 1.6 %      |
| Isc       | 0.51 A     | 0.44 A             | 15 %       |
| Rint      | 2.43 Ω     | 2.79 Ω             | 15 %       |
| Pmax      | 0.156 W    | 0.132 W            | 15 %       |

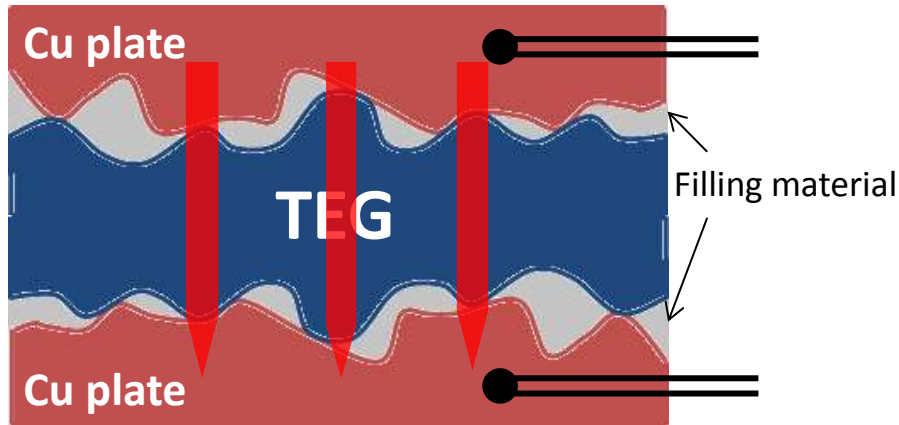
Working mode might depend on the application

Careful:

- Time per measurement
- Comparisons in round-robins



## Thermal contact resistance

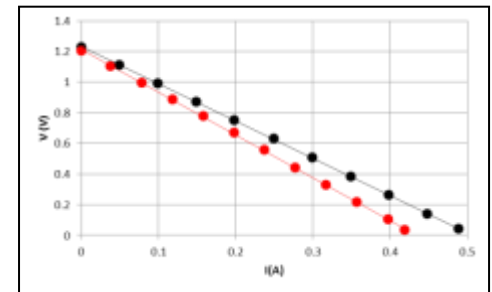


$$P \cdot R = \Delta T$$

$$R_T = R_{plate} + R_c + R_{TEG} + R_c + R_{plate}$$

What's the role of the contact resistance?

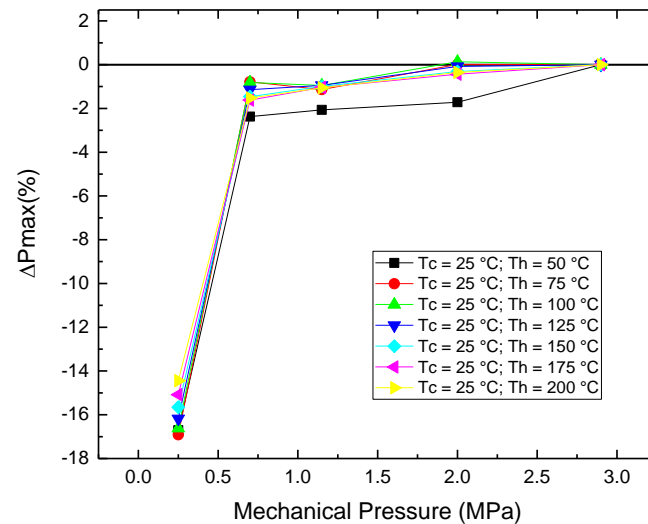
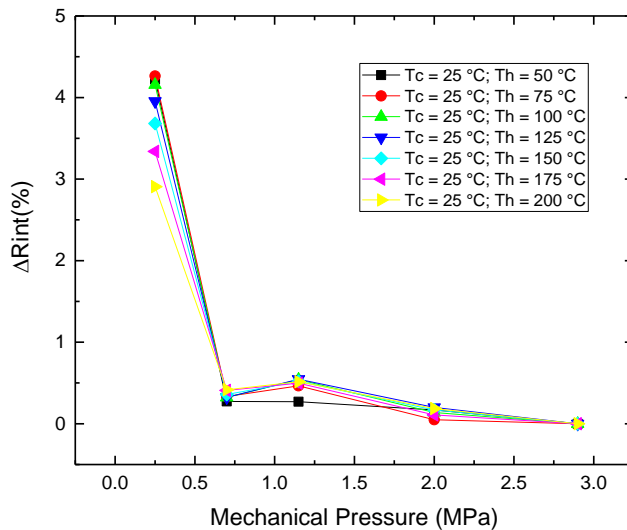
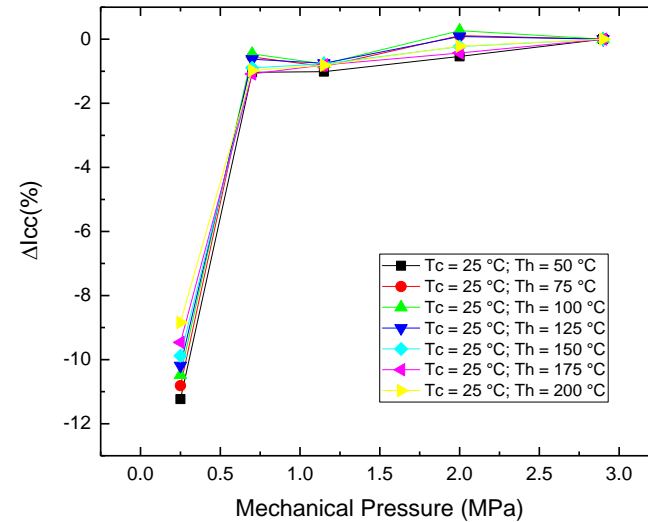
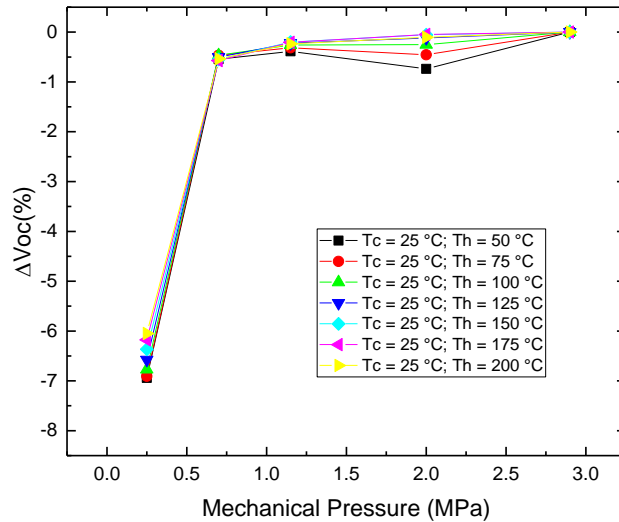
- Reduction of the heat flux → reduction of the efficiency
- False measurement of temperature
- Influence on characterisation results (Peltier effect)



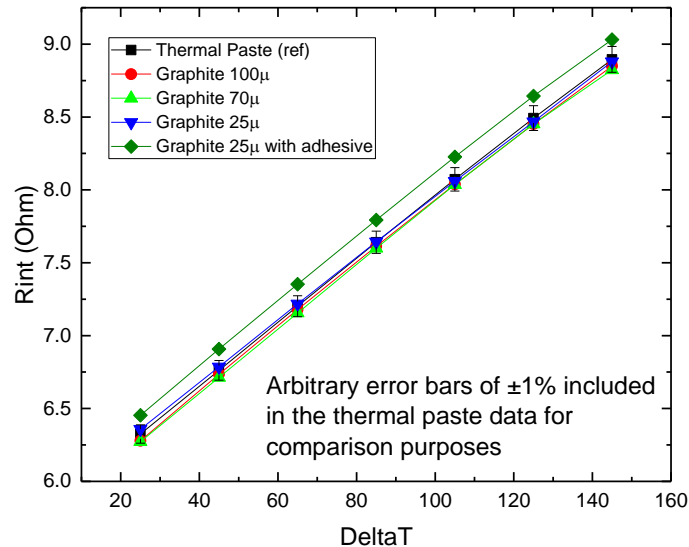
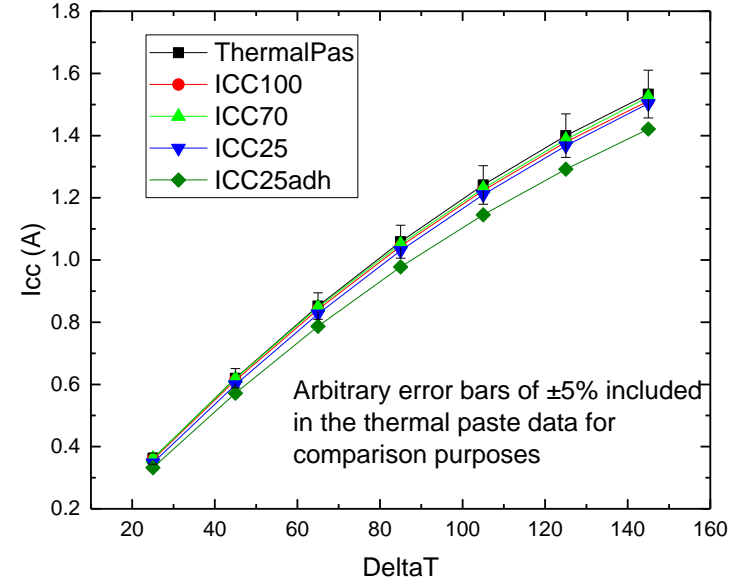
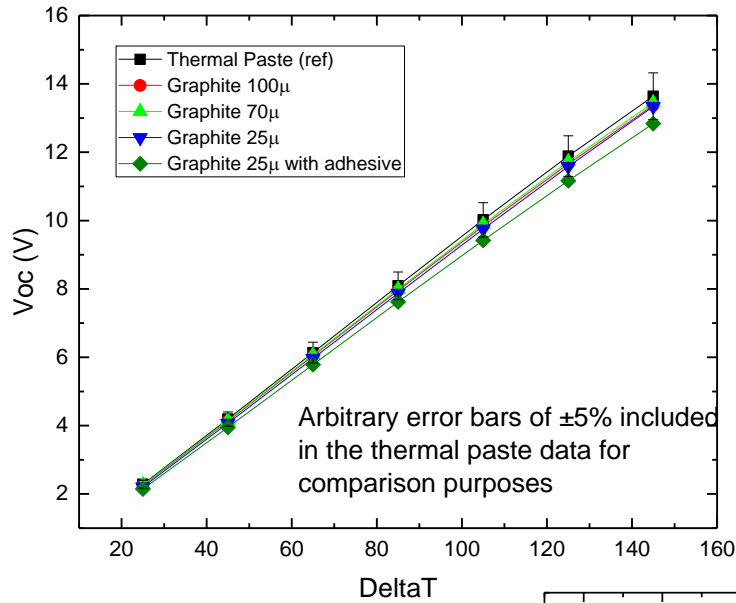
Contact resistance → {

- Clamping pressure
- Interface material

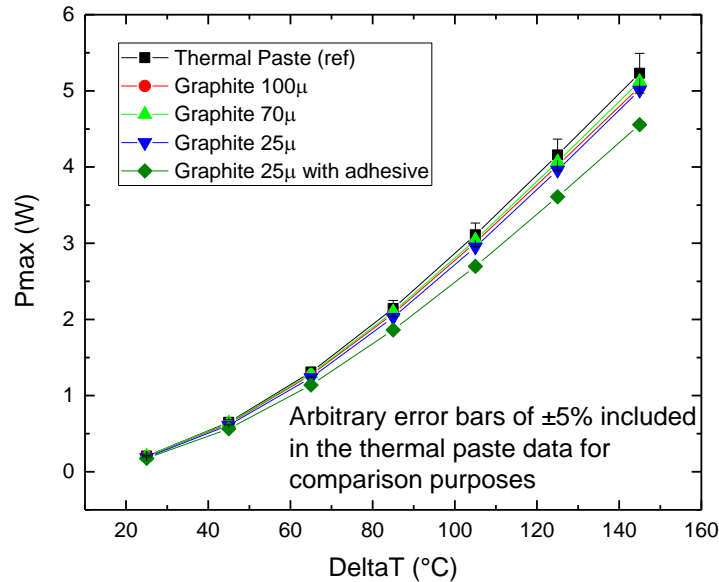
**Clamping pressure:** • Minimum pressure needed!



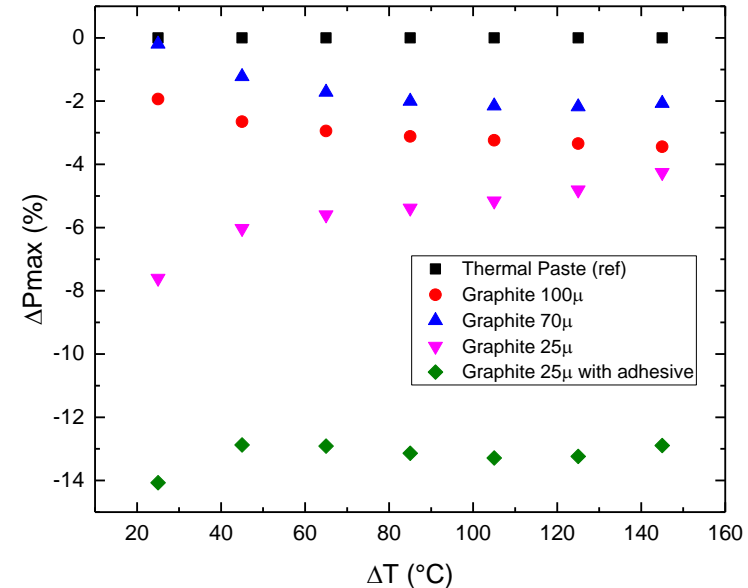
## Interface materials: Thermal paste Vs Graphite paper



## Interface materials: Thermal paste Vs Graphite paper



Relative change in maximum power output with different interface materials (with respect to thermal paste)



### Thermal paste:

- Lower contact resistance
- High dependence on the thickness and homogeneity

### Graphite paper: more reproducible results

| Parameter          | Voc | Isc | Rint | Pmax |
|--------------------|-----|-----|------|------|
| Average difference | 4 % | 10% | 5%   | 14%  |

## Precision: reproducibility



|                       |               |                          |
|-----------------------|---------------|--------------------------|
| Repeatability         | $u_c = 0.1\%$ | Level of confidence: 68% |
| Combined uncertainty: | $u_c = 2.9\%$ | Level of confidence: 68% |
| Extended uncertainty: | $U = 5.8\%$   | Level of confidence: 95% |

## Accuracy: traceability

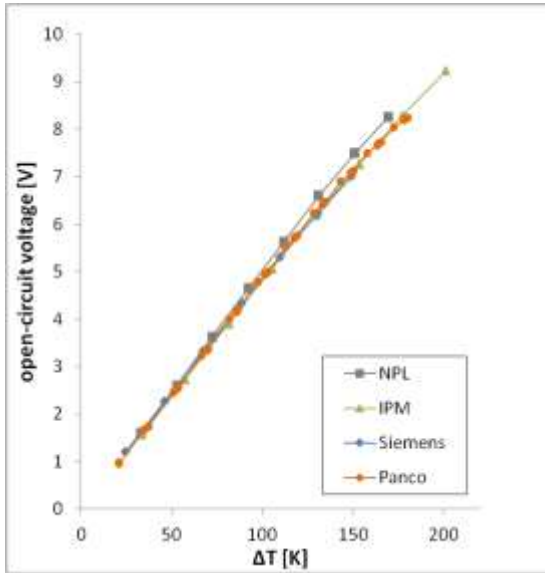
- Use standards for calibration
- Round-robin among Institutions

Sources of discrepancies:

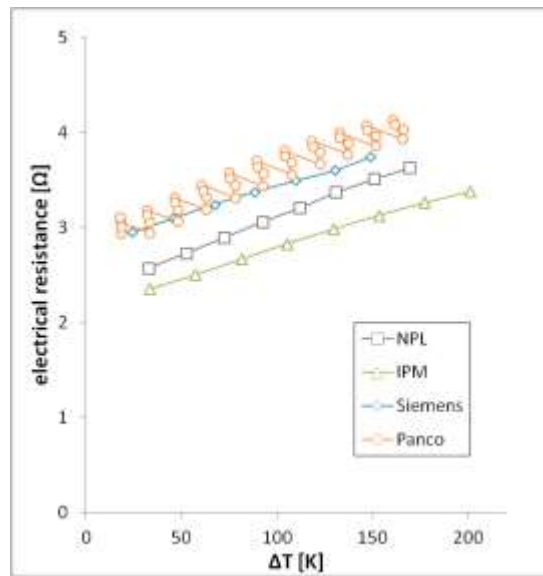
- Interface material
- Clamping pressure
- Constant heat flux or constant temperature
- Mean temperature (cold temperature)
- ...

# Comparison of module properties measurement

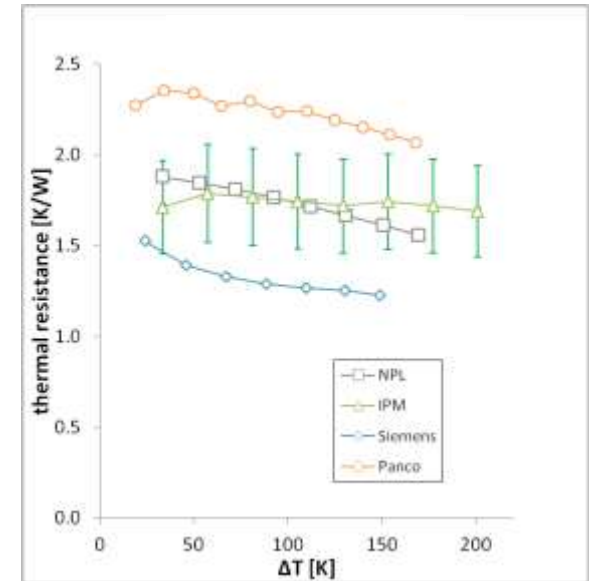
Open-circuit voltage



Internal electrical resistance



Thermal resistance



- Open-circuit voltage: Good agreement
- Internal electrical resistance: Unexpected scatter
- Thermal resistance: Expected scatter



Open NPL test bench for TE module conversion efficiency

Siemens test bench for TE module conversion efficiency



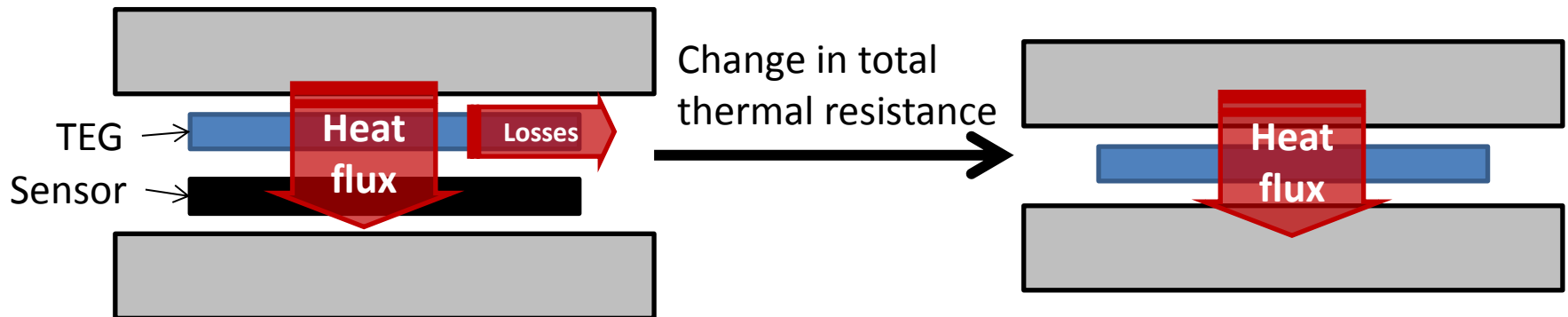


## Efficiency: measuring the heat flux

$$P \cdot R = \Delta T$$

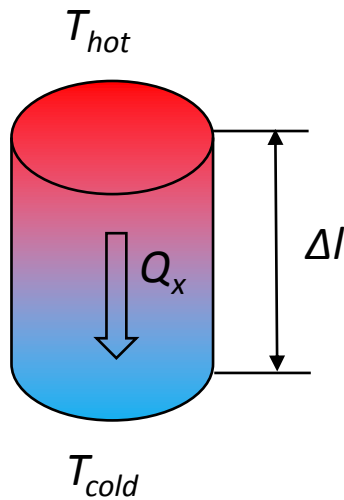
Heat flux sensor in series:

- Different total thermal resistance → different heat flux,
- Loss of control of the temperature in the contact surface of the TEG



**Discrepancies in efficiency of up to 20 %**

# ■ Thermal conductivity measurements



$Q_x$  – amount of heat

Measurement of  $Q_x$  – primary source of error

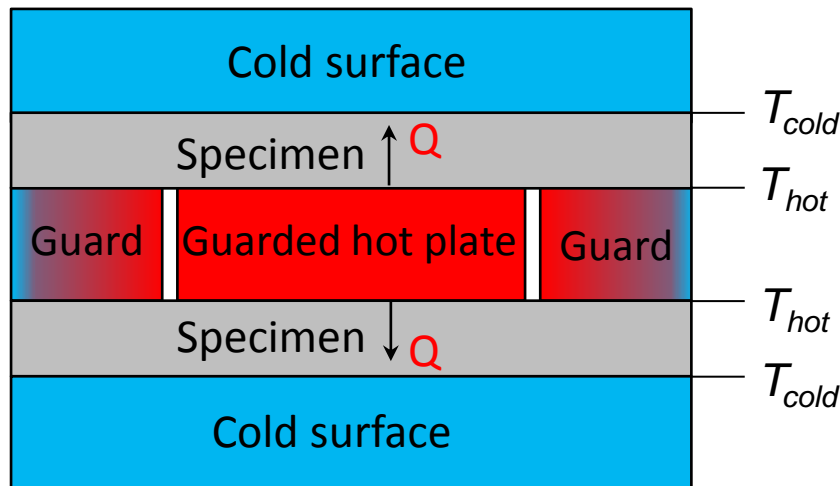
Ways to measure  $Q_x$ :

- Directly (absolute methods)
- Indirectly (comparative methods)

Fourier's law for heat conduction:

$$\frac{Q_x}{A} = -\kappa \frac{\partial T}{\partial x} = -\kappa \frac{\Delta T}{\Delta l}$$

# Guarded Hot Plate (ASTM-C177, ISO 8302)



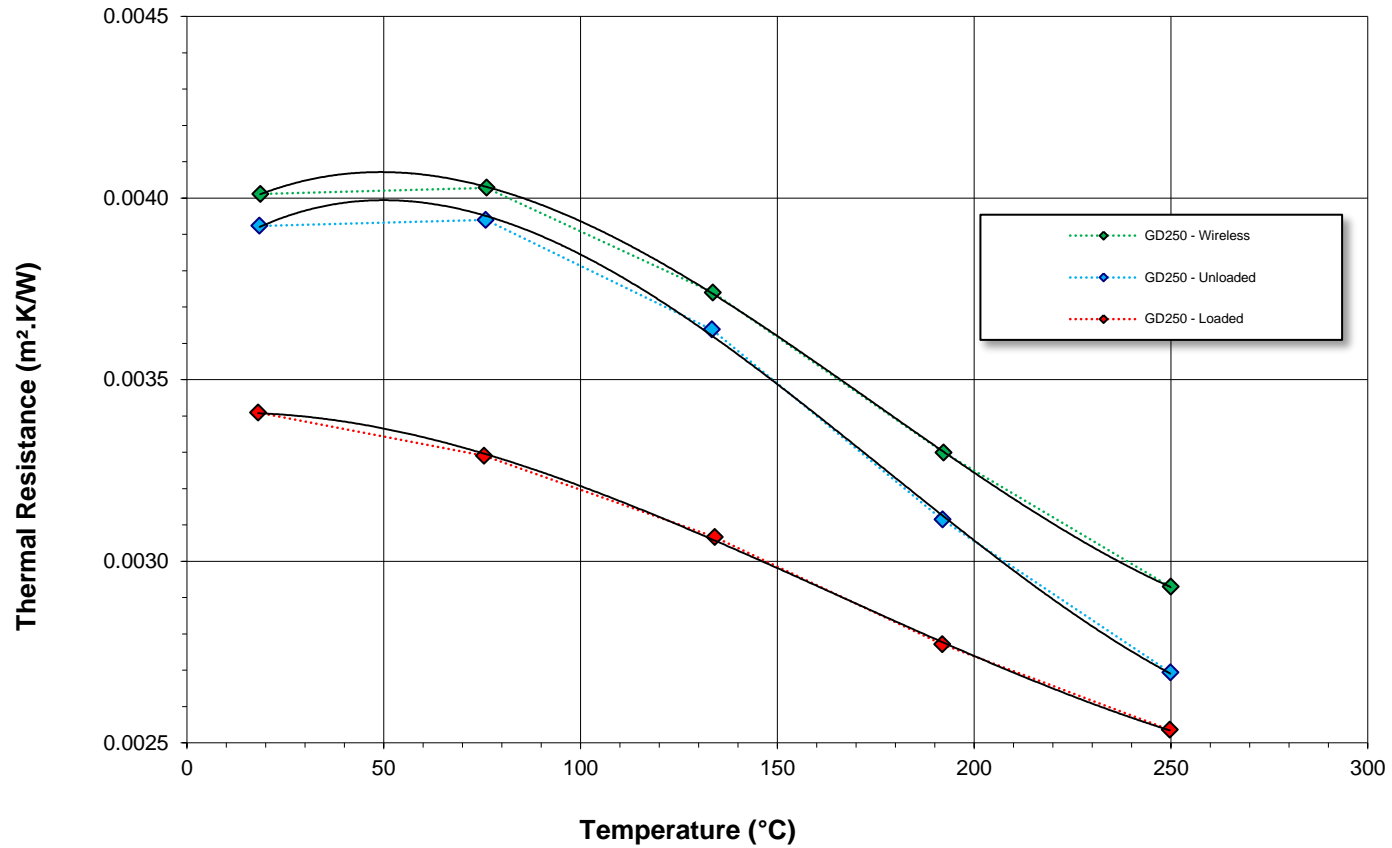
- Specimen geometry: large ratio of area to thickness
- The guard heater limits the lateral heat flow
- Balancing the temperatures of the gap – main source of error
- Use of edge insulation and secondary guard at high T

Uncertainty:

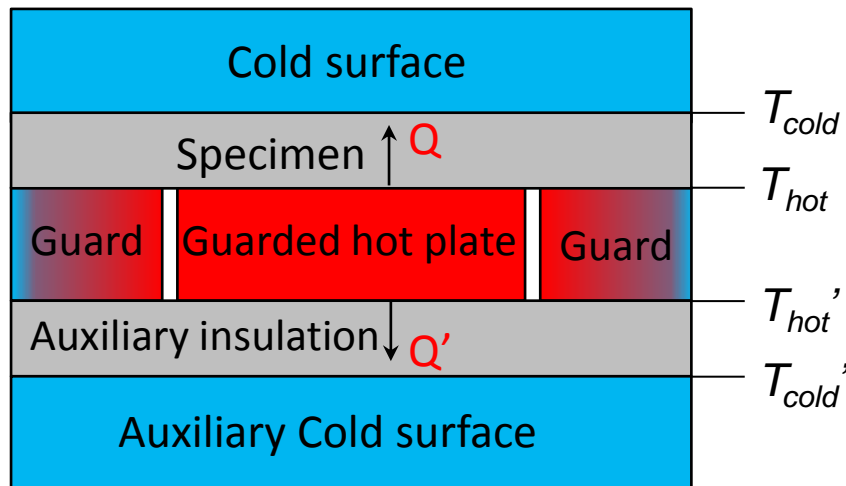
$\pm 2\%$  at RT

$\pm 5\%$  full operating range

# Module thermal resistance



# Guarded Hot Plate Single-Sided Mode (ASTM-C1044)



Uncertainty:

Slightly larger than double-sided mode

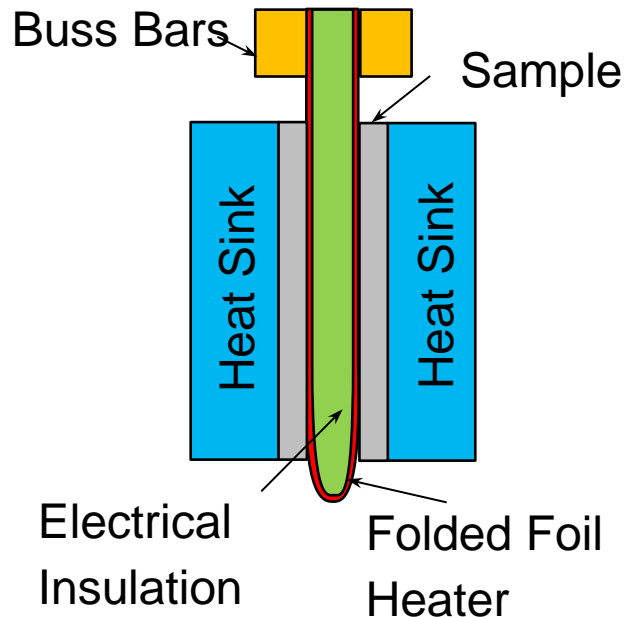
- Independent temperature control for  $T_{cold}$  and  $T_{cold}'$

$$T_{hot} = T_{hot}' = T_{cold}'; Q' = 0 \text{ (principle)}$$

$$T_{hot} \approx T_{hot}' \approx T_{cold}'; Q' \approx 0 > 1\% \text{ (practice)}$$

- Additional errors from balancing the gap if equipment was initially designed for double-side operation

# Thin Heater Apparatus (ASTM-C1114)



- Low lateral thermal conductance of the heater avoids the need for insulation and the guard
- Steady-state is reached in shorter time than that of ASTM-C177

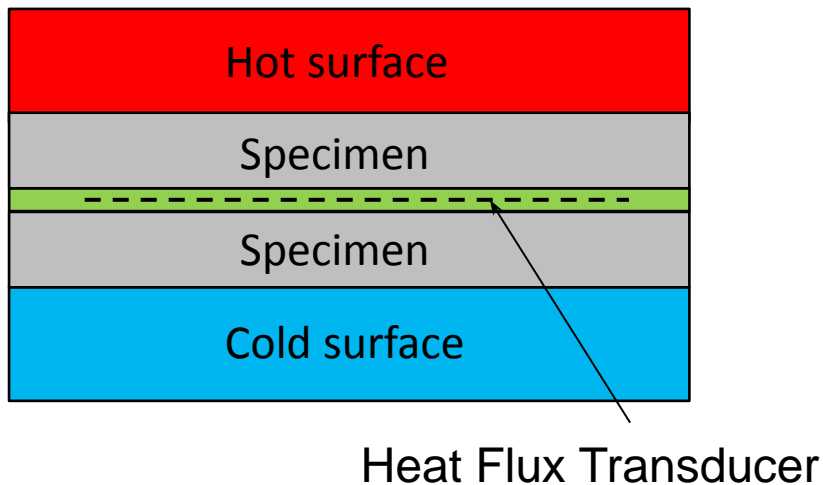
Uncertainty:

$\pm 3\%$  (300 – 550K)



- Comparative methods

## Heat flow meter apparatus (ASTM-C518)



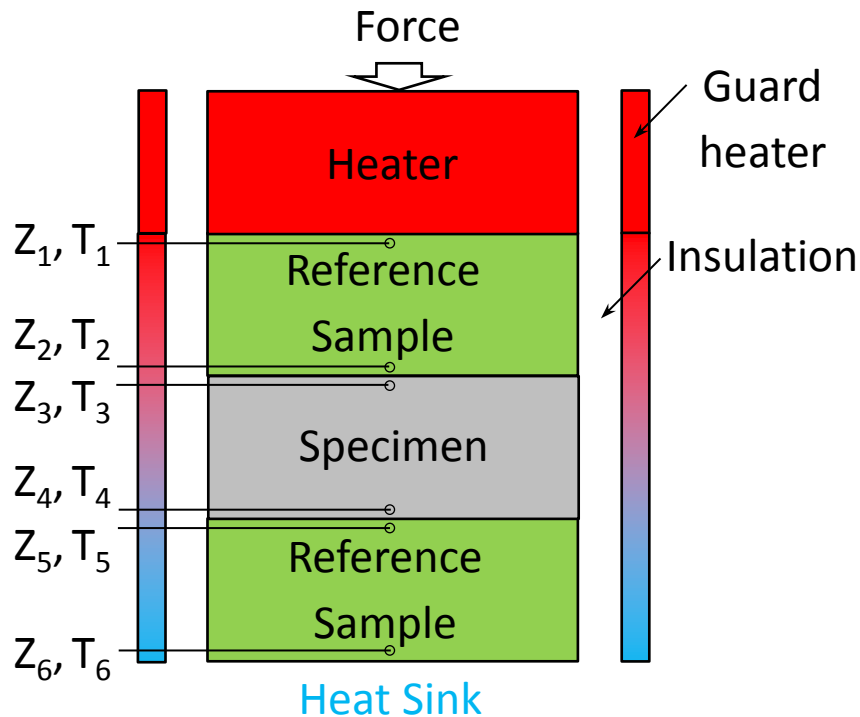
- Rapid, applicable to a wide range of test specimen
- Calibration of heat transducer required. To be calibrated with materials with similar thermal characteristics and thicknesses as the materials to be evaluated

Uncertainty:

Within  $\pm 2\%$  of those determined by

Guarded Hot Plate method (ASTM-C177)

# Guarded Longitudinal Heat Flow (ASTM-E1225,-D5470)

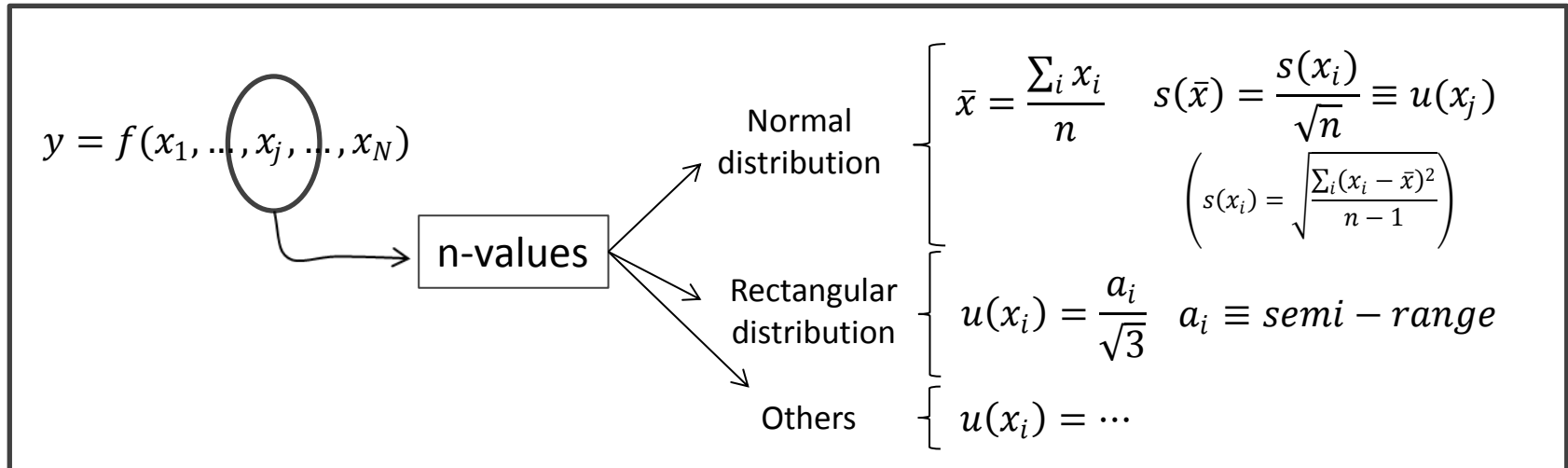


- No heat flux measurements required
- Reference bars with similar thermal characteristics and cross-sections as the materials to be evaluated
- $\kappa_{ref} > 50 \text{ W/mK}$

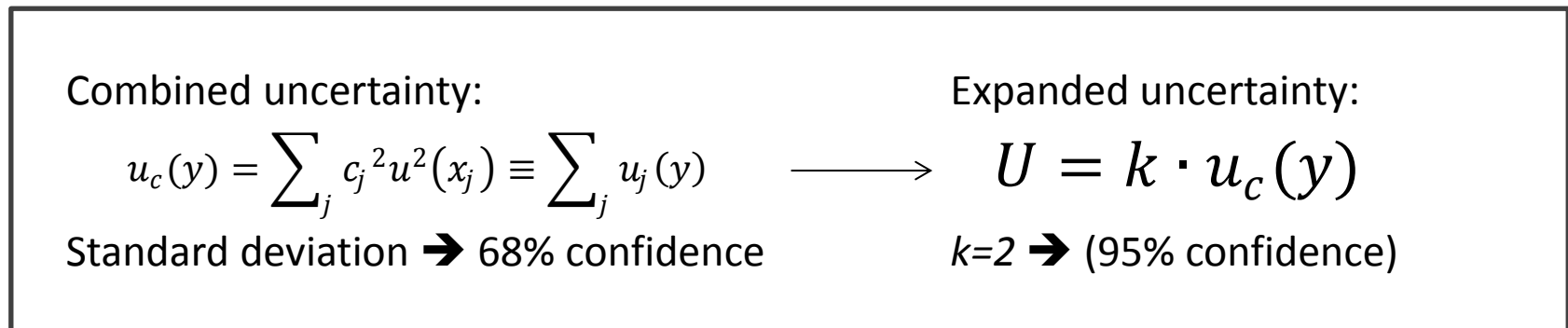
$$\kappa = \frac{Z_4 - Z_3}{T_4 - T_3} \cdot \frac{\kappa_{ref}}{2} \cdot \left( \frac{T_2 - T_1}{Z_2 - Z_1} + \frac{T_6 - T_5}{Z_6 - Z_5} \right)$$

## How:

- Identify sources of uncertainty
- Obtain their contributions: distribution probability (normal, triangular, square...)



- Obtain combined uncertainty: level of confidence



## Uncertainty contributions (for precision)

| Parameter                                | Repeatability | Clamping Pressure<br>(3 MPa < P < 12 MPa) | Interface material | Mean T<br>(during V-I) | Temperature stability | Instruments |
|------------------------------------------|---------------|-------------------------------------------|--------------------|------------------------|-----------------------|-------------|
| Uncertainty contribution to Power Output | < 0.1 %       | < 0.3 %                                   | < 0.2 %            | < 0.8 %                | < 0.5 %               | < 1.0 %     |

# CONCLUSIONS

- Facility to characterise thermoelectric modules has been built at NPL with a power output repeatability of 0.1%.
- Main sources of uncertainty and discrepancies have been identified and discussed:
  - Mean temperature
  - Const Heat Flux Vs Const Delta T
  - Interface material
- Heat flux measurement has higher uncertainty.
- A complete uncertainty study is being done.